Vorläufige Daten
Preliminary Data

IGBT,Wechselrichter / IGBT,Inverter

Höchstzulässige Werte / Maximum Rated Values

Kollektor-Emitter-Sperrspannung Collector-emitter voltage	T_{vj} = 25°C	V_{CES}	1200		V
Kollektor-Dauergleichstrom Continuous DC collector current	T_C = 70°C, $T_{vj\,max}$ = 150°C T_C = 25°C, $T_{vj\,max}$ = 150°C	$I_{C\,nom}$ I_C	75 100		A A
Periodischer Kollektor-Spitzenstrom Repetitive peak collector current	t_P = 1 ms	I_{CRM}	150		A
Gesamt-Verlustleistung Total power dissipation	T_C = 25°C, $T_{vj\,max}$ = 150	P_{tot}	500		W
Gate-Emitter-Spitzenspannung Gate-emitter peak voltage		V_{GES}	+/-20		V

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage	I_C = 75 A, V_{GE} = 15 V I_C = 75 A, V_{GE} = 15 V	T_{vj} = 25°C T_{vj} = 125°C	$V_{CE\,sat}$		3,20 3,85	3,70	V V
Gate-Schwellenspannung Gate threshold voltage	I_C = 3,00 mA, V_{CE} = V_{GE}, T_{vj} = 25°C		V_{GEth}	4,5	5,5	6,5	V
Gateladung Gate charge	V_{GE} = -15 V ... +15 V		Q_G		0,80		µC
Interner Gatewiderstand Internal gate resistor	T_{vj} = 25°C		R_{Gint}		5,0		Ω
Eingangskapazität Input capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{ies}		5,10		nF
Rückwirkungskapazität Reverse transfer capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{res}		0,32		nF
Kollektor-Emitter-Reststrom Collector-emitter cut-off current	V_{CE} = 1200 V, V_{GE} = 0 V, T_{vj} = 25°C		I_{CES}			5,0	mA
Gate-Emitter-Reststrom Gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25°C		I_{GES}			400	nA
Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load	I_C = 75 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Gon} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	$t_{d\,on}$		0,12 0,13		µs µs
Anstiegszeit, induktive Last Rise time, inductive load	I_C = 75 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Gon} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	t_r		0,05 0,06		µs µs
Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load	I_C = 75 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Goff} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	$t_{d\,off}$		0,31 0,36		µs µs
Fallzeit, induktive Last Fall time, inductive load	I_C = 75 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Goff} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	t_f		0,02 0,03		µs µs
Einschaltverlustenergie pro Puls Turn-on energy loss per pulse	I_C = 75 A, V_{CE} = 600 V, L_S = 30 nH V_{GE} = ±15 V R_{Gon} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	E_{on}		9,00		mJ mJ
Abschaltverlustenergie pro Puls Turn-off energy loss per pulse	I_C = 75 A, V_{CE} = 600 V, L_S = 30 nH V_{GE} = ±15 V R_{Goff} = 7,5 Ω	T_{vj} = 25°C T_{vj} = 125°C	E_{off}		3,80		mJ mJ
Kurzschlußverhalten SC data	V_{GE} ≤ 15 V, V_{CC} = 900 V V_{CEmax} = V_{CES} -L_{sCE} ·di/dt	t_P ≤ 10 µs, T_{vj} = 125°C	I_{SC}		450		A
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro IGBT / per IGBT		R_{thJC}			0,25	K/W
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj\,op}$	-40		125	°C

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Vorläufige Daten
Preliminary Data

Diode, Wechselrichter / Diode, Inverter

Höchstzulässige Werte / Maximum Rated Values

Periodische Spitzensperrspannung Repetitive peak reverse voltage	T_{vj} = 25°C	V_{RRM}	1200	V
Dauergleichstrom Continuous DC forward current		I_F	75	A
Periodischer Spitzenstrom Repetitive peak forward current	t_P = 1 ms	I_{FRM}	150	A
Grenzlastintegral I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C	I²t	2450	A²s

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Durchlassspannung Forward voltage	I_F = 75 A, V_{GE} = 0 V I_F = 75 A, V_{GE} = 0 V	T_{vj} = 25°C T_{vj} = 125°C	V_F		2,00 1,70	2,40	V V
Rückstromspitze Peak reverse recovery current	I_F = 75 A, - di_F/dt = 1800 A/µs (T_{vj}=125°C) V_R = 600 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C	I_{RM}		65,0 95,0		A A
Sperrverzögerungsladung Recovered charge	I_F = 75 A, - di_F/dt = 1800 A/µs (T_{vj}=125°C) V_R = 600 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C	Q_r		5,25 14,0		µC µC
Abschaltenergie pro Puls Reverse recovery energy	I_F = 75 A, - di_F/dt = 1800 A/µs (T_{vj}=125°C) V_R = 600 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C	E_{rec}		1,80 4,50		mJ mJ
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro Diode / per diode		R_{thJC}			0,43	K/W
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj\,op}$	-40		125	°C

Modul / Module

Isolations-Prüfspannung Isolation test voltage	RMS, f = 50 Hz, t = 1 min	V_{ISOL}	2,5	kV
Innere Isolation Internal isolation	Basisisolierung (Schutzklasse 1, EN61140) basic insulation (class 1, IEC 61140)		Al_2O_3	
Kriechstrecke Creepage distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		10,0	mm
Luftstrecke Clearance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		7,5	mm
Vergleichszahl der Kriechwegbildung Comperative tracking index		CTI	> 225	

			min.	typ.	max.	
Wärmewiderstand, Gehäuse bis Kühlkörper Thermal resistance, case to heatsink	pro Modul / per module λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		0,009		K/W
Modulstreuinduktivität Stray inductance module		L_{sCE}		28		nH
Modulleitungswiderstand, Anschlüsse - Chip Module lead resistance, terminals - chip	T_C = 25°C, pro Schalter / per switch	$R_{CC'+EE'}$		1,80		mΩ
Lagertemperatur Storage temperature		T_{stg}	-40		125	°C
Anzugsdrehmoment f. Modulmontage Mounting torque for modul mounting	Schraube M5 - Montage gem. gültiger Applikationsschrift Screw M5 - Mounting according to valid application note	M	3,00	-	6,00	Nm
Gewicht Weight		G		300		g

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Vorläufige Daten
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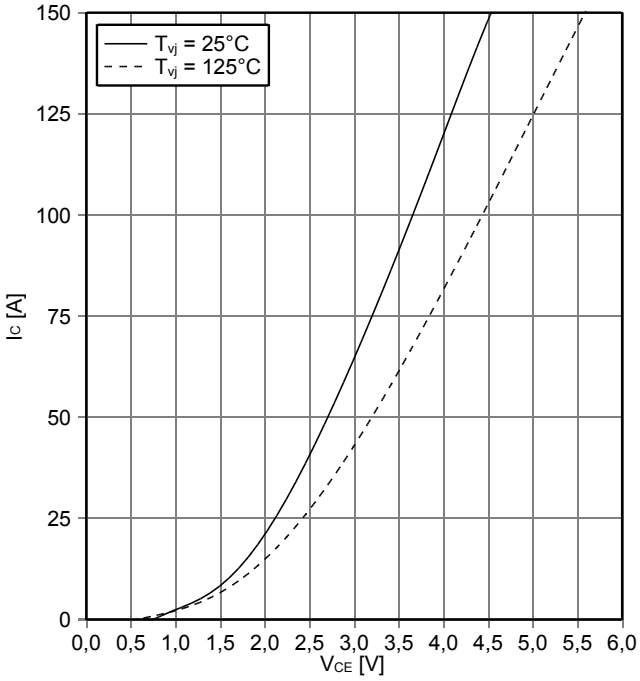
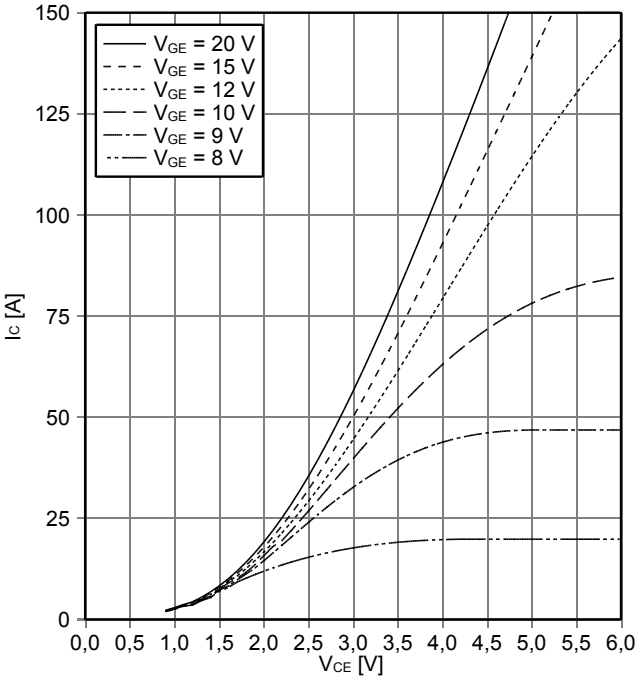
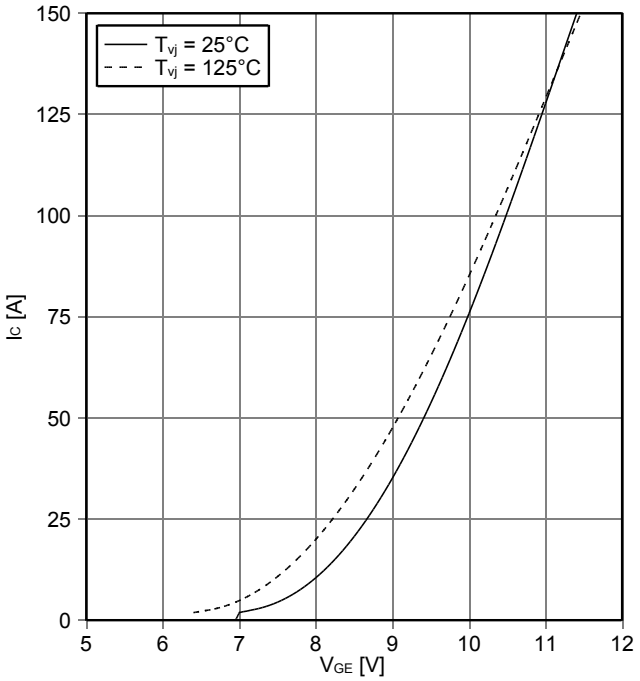
Ausgangskennlinie IGBT,Wechselrichter (typisch)
output characteristic IGBT,Inverter (typical)
$I_C = f(V_{CE})$
V_{GE} = 15 V



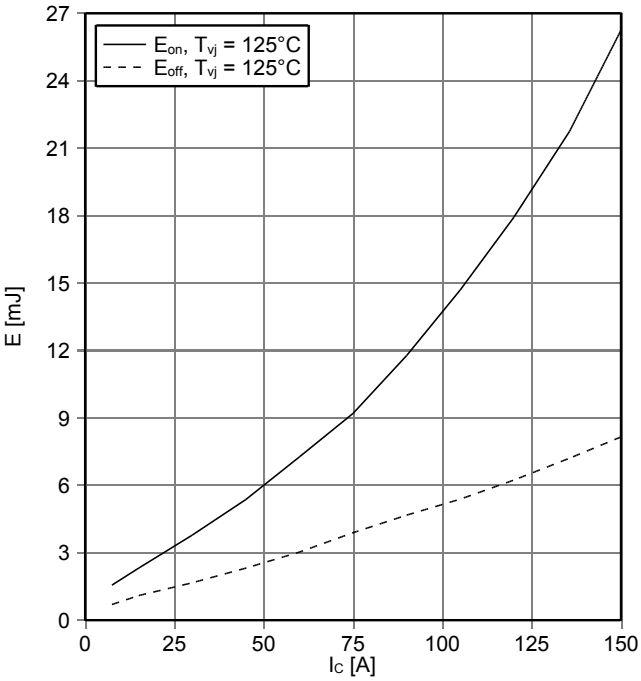
Ausgangskennlinienfeld IGBT,Wechselrichter (typisch)
output characteristic IGBT,Inverter (typical)
$I_C = f(V_{CE})$
T_{vj} = 125°C



Übertragungscharakteristik IGBT,Wechselrichter (typisch)
transfer characteristic IGBT,Inverter(typical)
$I_C = f(V_{GE})$
V_{CE} = 20 V



SchaltverlusteIGBT,Wechselrichter (typisch)
switching losses IGBT,Inverter (typical)
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$
V_{GE} = ±15 V, R_{Gon} = 7.5 Ω, R_{Goff} = 7.5 Ω, V_{CE} = 600 V



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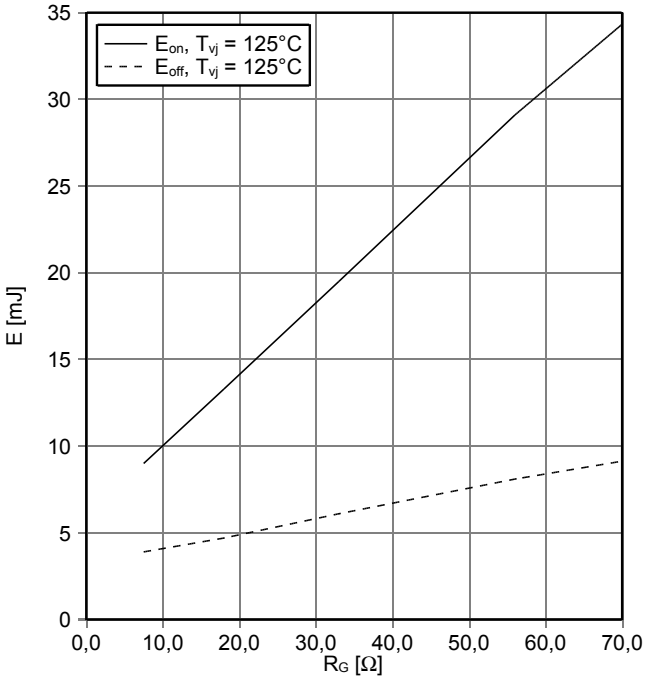
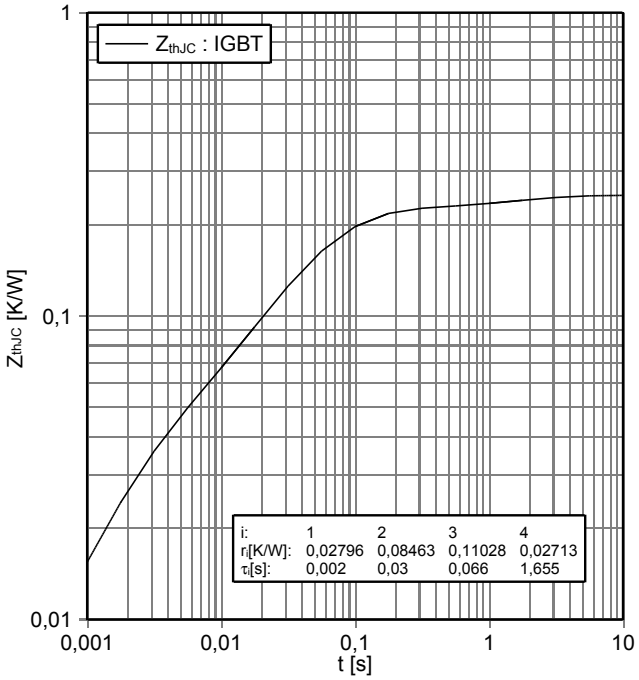
Vorläufige Daten
Preliminary Data

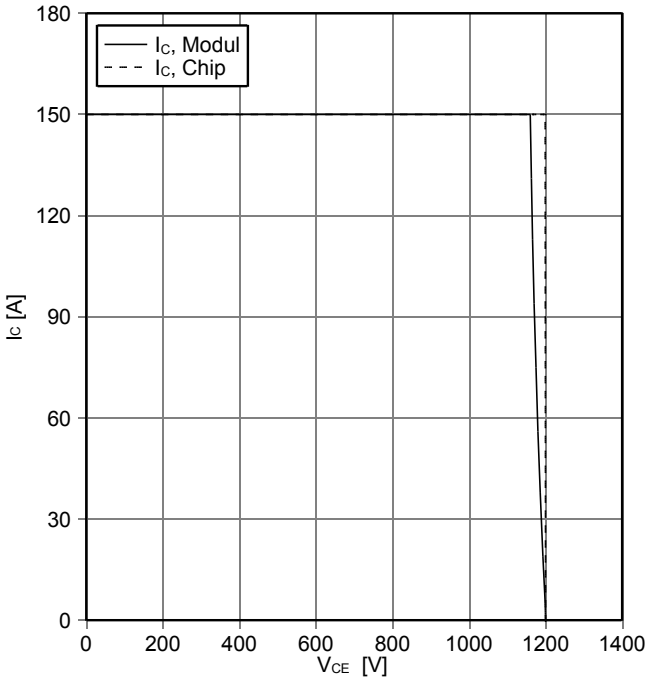
SchaltverlusteIGBT,Wechselrichter (typisch)
switching losses IGBT,Inverter (typical)
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$
V_{GE} = ±15 V, I_C = 75 A, V_{CE} = 600 V



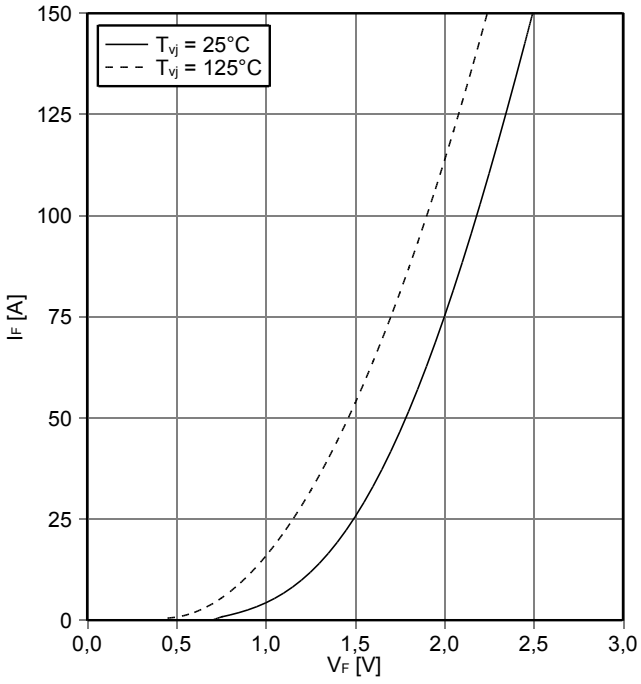
Transienter Wärmewiderstand IGBT,Wechselrichter
transient thermal impedance IGBT,Inverter
$Z_{thJC} = f(t)$



Sicherer Rückwärts-Arbeitsbereich IGBT,Wechselrichter (RBSOA)
reverse bias safe operating area IGBT,Inverter (RBSOA)
$I_C = f(V_{CE})$
V_{GE} = ±15 V, R_{Goff} = 7.5 Ω, T_{vj} = 125°C



Durchlasskennlinie der Diode, Wechselrichter (typisch)
forward characteristic of Diode, Inverter (typical)
$I_F = f(V_F)$



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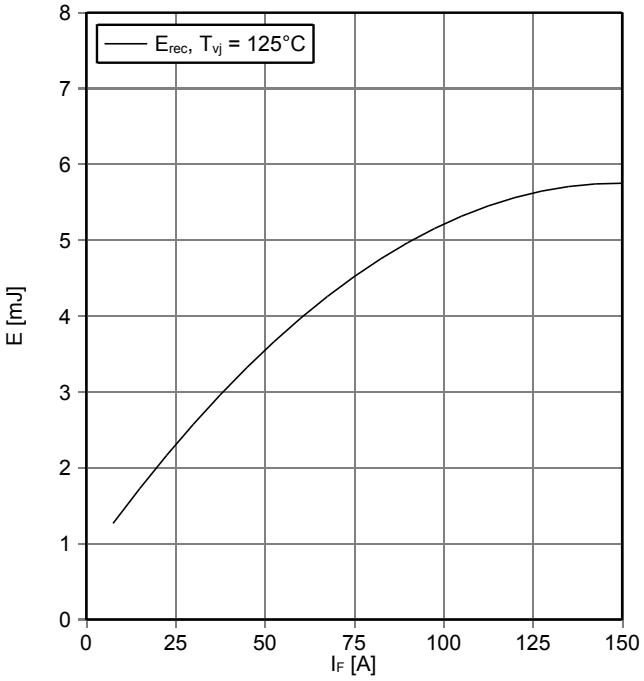
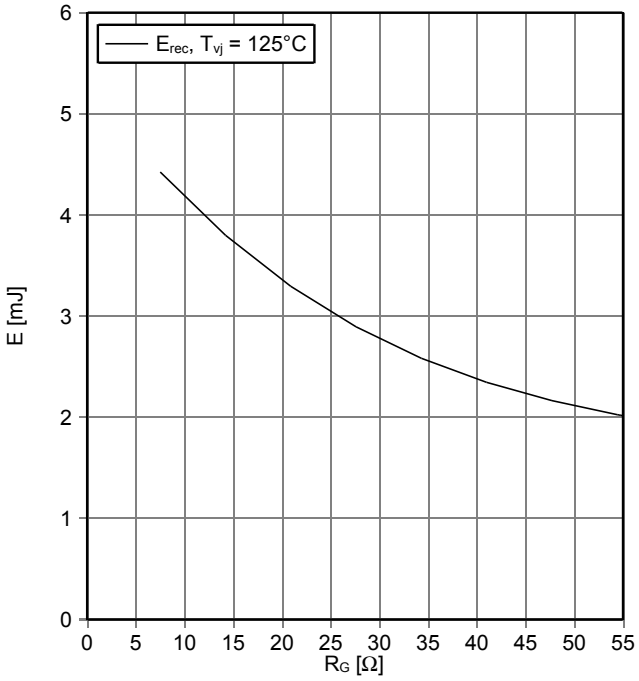
Vorläufige Daten
Preliminary Data

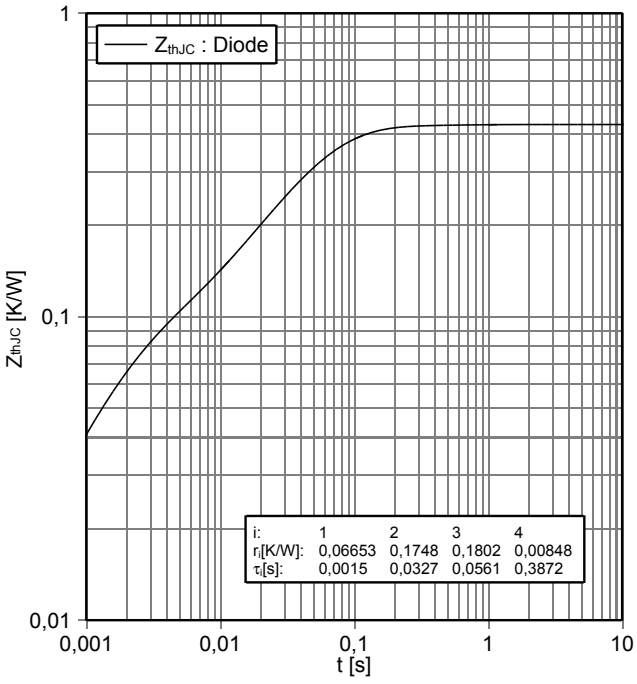
Schaltverluste Diode, Wechselrichter (typisch)
switching losses Diode, Inverter (typical)
$E_{rec} = f(I_F)$
$R_{Gon} = 7.5\ \Omega$, $V_{CE} = 600$ V



Schaltverluste Diode, Wechselrichter (typisch)
switching losses Diode, Inverter (typical)
$E_{rec} = f(R_G)$
$I_F = 75$ A, $V_{CE} = 600$ V



Transienter Wärmewiderstand Diode, Wechselrichter
transient thermal impedance Diode, Inverter
$Z_{thJC} = f(t)$



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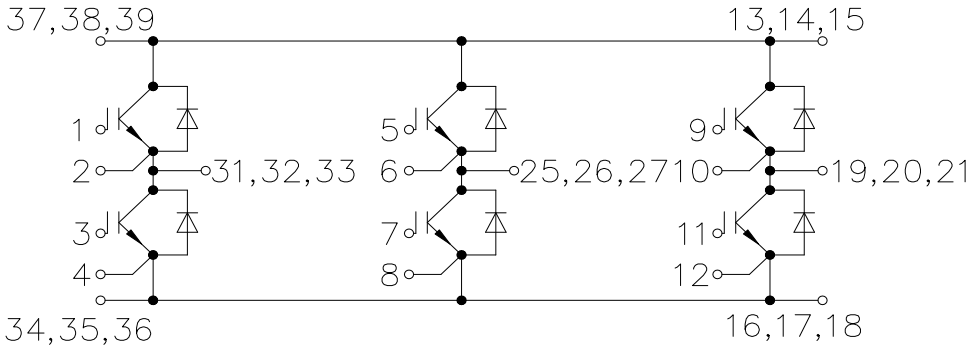
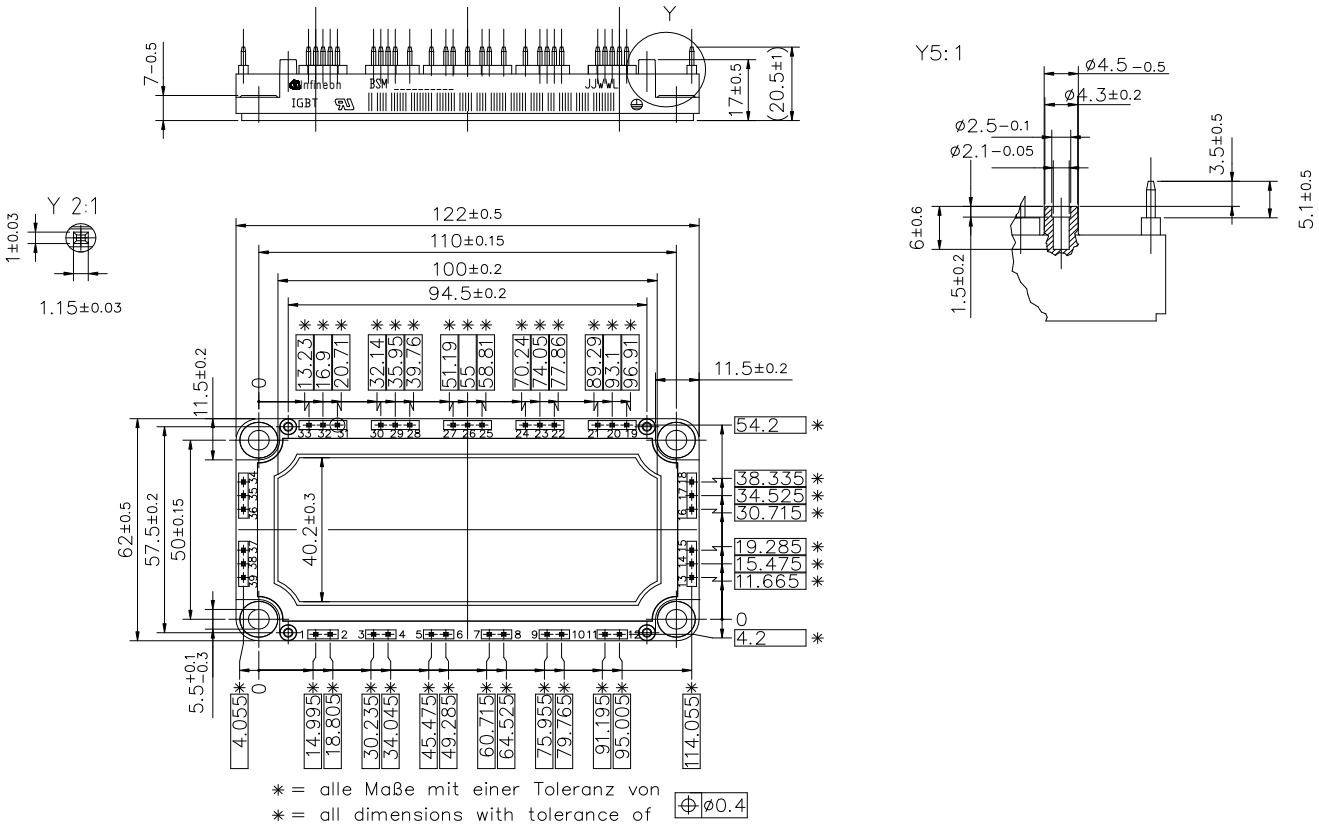
Vorläufige Daten
Preliminary Data

Schaltplan / circuit_diagram_headline



Gehäuseabmessungen / package outlines



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